





Device Specification

ELECTRICAL CHARACTERISTICS

Part Number	Marking	I _{hold} (A)	I _{trip} (A)	V _{max} (Vdc)	I _{max} (A)	Pd _{max} (W)	Maximum Time-to-Trip		Resistance	
							Current (A)	Time (Sec.)	$rac{\mathbf{R}_{\min}}{(\Omega)}$	$\begin{array}{c} \mathbf{R}_{1\max} \\ (\Omega) \end{array}$
0603L300/9SL	Z	3.00	6.00	9	50	0.60	8.00	1.00	0.003	0.030

Note: I_{hold} = Hold current: maximum current device will pass without tripping in 20°C still air.

 I_{trip} = Trip Current: minimum current at which the device will trip in 20°C still air.

 V_{max} = Maximum voltage device can withstand without damage at rated current (Imax)

 I_{max} = Maximum fault current device can withstand without damage at rated voltage (Vmax)

Pd = Power dissipated from device when in the tripped state at 20° C still air.

 R_{min} = Minimum resistance of device in initial (un-soldered) state.

 R_{1max} = Maximum resistance of device at 20°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

Caution :Operation beyond the specified rating may result in damage and possible arcing and flame.



Solder Pad Layout (mm)



PHYSICAL DIMENSIONS (mm)

Part Number	Α		В		С		D		Е	
I alt Number	Min.	Max.								
0603L300/9SL	1.40	1.80	0.60	1.00	0.40	1.00	0.15	0.50		0.40

RoHS 🕅

THERMAL DERATING CHART – Ihold/Itrip (Amps)

Recommended Data

Part Number		Ambient Operation Temperature									
		-40 °C	-20 °C	℃ 0	23 °C	40 ℃	50 ℃	60 °C	70 ℃	85 °C	
0603L300/9SL	Ihold	4.70	4.15	3.60	3.00	2.50	2.20	2.00	1.65	1.20	
	I _{trip}	9.50	8.30	7.30	6.00	5.00	4.40	4.00	3.30	2.50	

AVERAGE TIME-CURRENT CURVE

